

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3547200

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	JEFFREY S. LEAL	12/01/2010
RECEIVING PARTY DATA		
Name:	VERTICAL CIRCUITS, INC.	
Street Address:	10 VICTOR SQUARE	
City:	SCOTTS VALLEY	
State/Country:	CALIFORNIA	
Postal Code:	95066	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14868090
CORRESPONDENCE DATA		
Fax Number:	(908)654-7866	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
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ATTORNEY DOCKET NUMBER:	TIPI 3.0-855 CON (E)	
NAME OF SUBMITTER:	MELINDA C. CORMIER	
SIGNATURE:	/Melinda C. Cormier/	
DATE SIGNED:	09/29/2015	
Total Attachments: 2		
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**SOLE TO CORPORATE
ASSIGNMENT**

WHEREAS, the undersigned,

- (1) Jeffrey S. Leal
1001 Aviator Court
Scotts Valley, CA 95066

hereinafter termed "Inventor", has invented certain new and useful improvements in

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and has filed a provisional application for a United States patent disclosing and identifying the above invention on **27 October 2009** as Application No. **61/255,429**, and said Inventor has filed a non-provisional application for a United States patent disclosing and identifying the above invention on **27 October 2010** as Application No. **12/913,529**, OR is filing such an application herewith, and has executed an oath or declaration of inventorship for such non-provisional application on:

(1) the 1st day of December, 2010;

(hereinafter termed "Applications"); and

WHEREAS, Vertical Circuits, Inc., a corporation of Delaware, having a place of business at 10 Victor Square, Scotts Valley, CA 95066 (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said Applications and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Inventor (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventor to have been received in full from said Assignee:

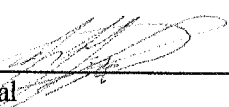
1. Said Inventor does hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said Applications and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise, including the right to claim priority from the Applications; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said Applications; and (d) in and to each and every reissue or extension of any of said patents.

2. Said Inventor hereby covenants and agrees to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventor shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said Applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor, the inventor's heirs, legal representatives and assigns.

4. The Inventor hereby warrants and represents that the Inventor has not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, said Inventor has executed and delivered this instrument to said Assignee as of the date written below.



Jeffrey S. Leal

Date: _____

12/1/10